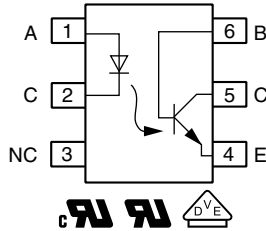


Optocoupler, Phototransistor Output, With Base Connection, High BV_{CEO} Voltage



23109



DESIGN SUPPORT TOOLS AVAILABLE



3D Models



Design Tools



Related Documents

DESCRIPTION

The H11Dx has a GaAs infrared emitting diode emitter, which is optically coupled to a silicon planar phototransistor detector, and is incorporated in a plastic DIP-6 package.

It features a high current transfer ratio, low coupling capacitance, and high isolation voltage.

The coupling device is designed for signal transmission between two electrically separated circuits.

FEATURES

- Very high collector emitter breakdown voltage $BV_{CEO} = 300\text{ V}$
- Isolation test voltage: 5000 V_{RMS}
- Low coupling capacitance
- High common mode transient immunity
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

AGENCY APPROVALS

- [UL1577](#)
- [cUL1577](#)
- [DIN EN 60747-5-5 \(VDE 0884-5\) available with option 1](#)

APPLICATIONS

- Telecom
- Industrial controls
- Battery powered equipment
- Office machines
- Programmable controllers

ORDERING INFORMATION				
<div style="display: flex; justify-content: space-around; align-items: center;"> <div style="border: 1px solid black; padding: 2px 5px;">H</div> <div style="border: 1px solid black; padding: 2px 5px;">1</div> <div style="border: 1px solid black; padding: 2px 5px;">1</div> <div style="border: 1px solid black; padding: 2px 5px;">D</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> <div style="border: 1px solid black; padding: 2px 5px;">-</div> <div style="border: 1px solid black; padding: 2px 5px;">X</div> <div style="border: 1px solid black; padding: 2px 5px;">0</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> </div>	PART NUMBER		PACKAGE OPTION	TAPE AND REEL
AGENCY CERTIFIED/PACKAGE	CTR (%)			
UL, cUL	> 20			
DIP-6	H11D1	H11D2	H11D3	
SMD-6, option 7	H11D1-X007T ⁽¹⁾	H11D2-X007	-	
SMD-6, option 9	H11D1-X009T ⁽¹⁾	-	-	
UL, cUL, VDE	> 20			
SMD-6, option 7	H11D1-X017T	-	-	

Notes

- Additional options may be possible, please contact sales office
- ⁽¹⁾ Also available in tubes; do not put T on the end



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V _R	6	V
Forward current			I _F	60	mA
Power dissipation			P _{diss}	100	mW
OUTPUT					
Collector emitter voltage		H11D1	V _{CEO}	300	V
		H11D2	V _{CEO}	300	V
		H11D3	V _{CEO}	200	V
Collector base voltage		H11D1	V _{CB0}	300	V
		H11D2	V _{CB0}	300	V
		H11D3	V _{CB0}	200	V
Emitter base voltage			V _{EBO}	7	V
Collector current			I _C	50	mA
Power dissipation			P _{diss}	150	mW
COUPLER					
Storage temperature range			T _{stg}	-55 to +125	°C
Operating temperature range			T _{amb}	-55 to +100	°C
Soldering temperature	t = 10 s	T _{sld}	T _{sld}	260	°C

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

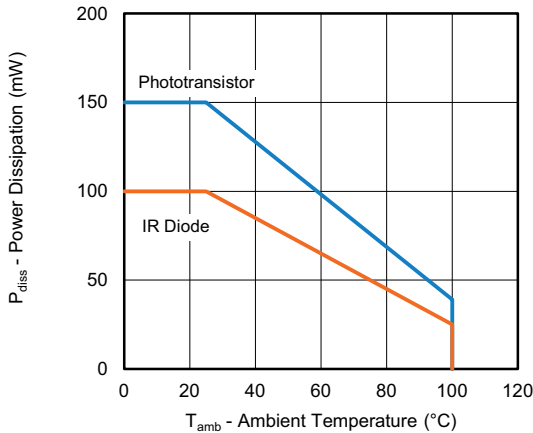


Fig. 1 - Power Dissipation vs. Ambient Temperature

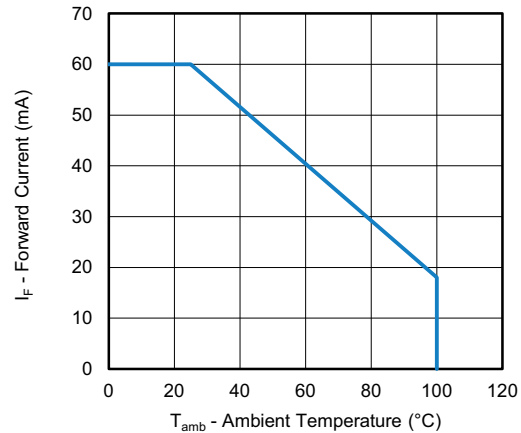


Fig. 2 - Maximum Forward Current vs. Ambient Temperature

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	I _F = 10 mA	V _F	-	1.2	1.5	V
Reverse voltage	I _R = 10 μA	V _R	6	-	-	V
Reverse current	V _R = 6 V	I _R	-	0.01	10	μA
Capacitance	V _R = 0 V, f = 1 kHz	C _I	-	30	-	pF
OUTPUT						
Collector emitter breakdown voltage	I _{CE} = 1 mA, R _{BE} = 1 MΩ	BV _{CEO}	300	-	-	V
Emitter base breakdown voltage	I _{EB} = 10 μA	BV _{EBO}	7	-	-	V

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
COUPLER						
Coupling capacitance	$V = 0\text{ V}$, $f = 1\text{ MHz}$	C_{IO}	-	0.6	-	pF
Collector emitter, saturation voltage	$I_F = 10\text{ mA}$, $I_C = 0.5\text{ mA}$, $R_{BE} = 1\text{ M}\Omega$	V_{CEsat}	-	0.25	0.4	V
Collector emitter leakage current	$V_{CE} = 200\text{ V}$, $R_{BE} = 1\text{ M}\Omega$	I_{CEO}	-	-	100	nA

Note

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

CURRENT TRANSFER RATIO						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
I_C/I_F	$I_F = 10\text{ mA}$, $V_{CE} = 10\text{ V}$	CTR	20	-	-	%

SWITCHING CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_C = 2\text{ mA}$, $R_L = 100\text{ }\Omega$, $V_{CC} = 5\text{ V}$	t_{on}	-	4	-	μs
Turn-off time	$I_C = 2\text{ mA}$, $R_L = 100\text{ }\Omega$, $V_{CC} = 5\text{ V}$	t_{off}	-	5	-	μs

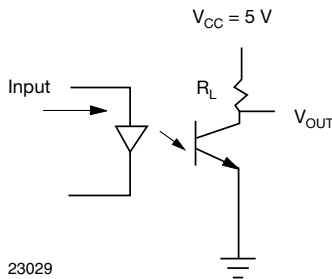


Fig. 3 - Test Circuit for Switching Characteristics

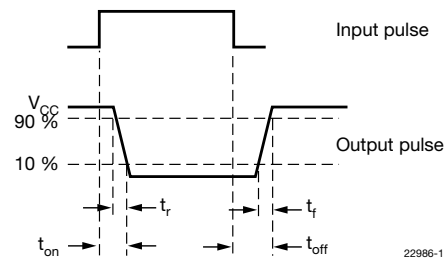


Fig. 4 - Parameter and Limit Definition

SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 115 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	V_{ISO}	5000	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	8000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	890	V_{peak}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	700	mW
Input safety current		I_{SI}	400	mA
Input safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance	DIP-6, SMD-6		≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

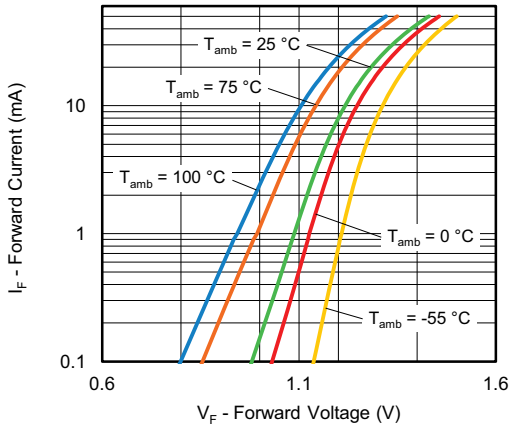


Fig. 5 - Forward Current vs. Forward Voltage

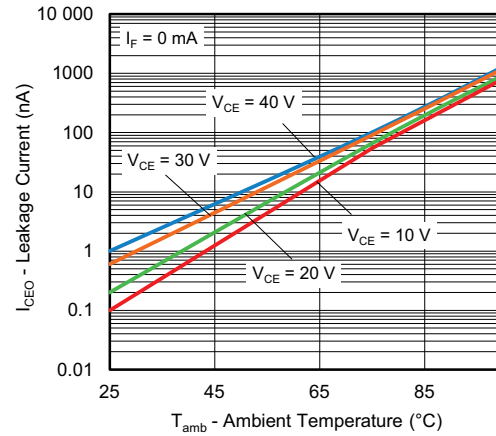


Fig. 8 - Leakage Current vs. Ambient Temperature

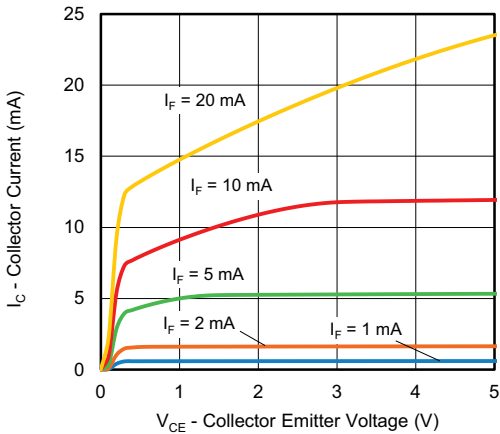


Fig. 6 - Collector Current vs. Collector Emitter Voltage (non-saturated)

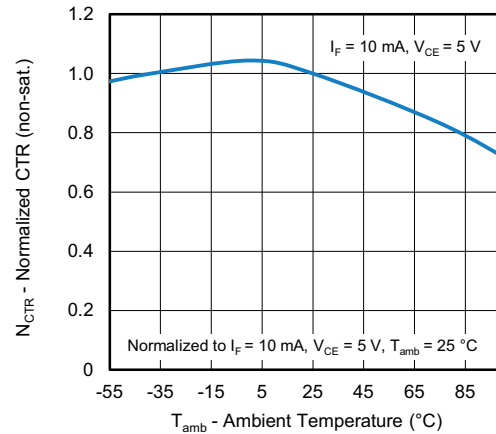


Fig. 9 - Normalized CTR vs. Ambient Temperature (non-saturated)

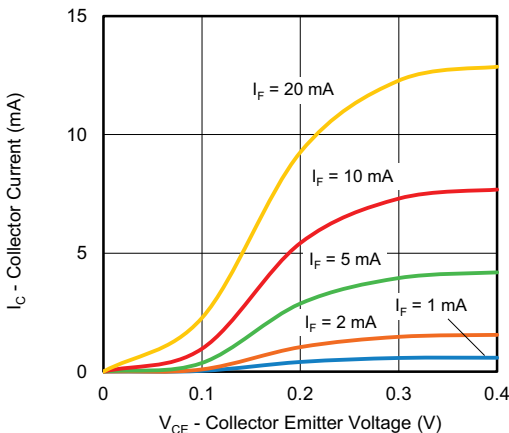


Fig. 7 - Collector Current vs. Collector Emitter Voltage (saturated)

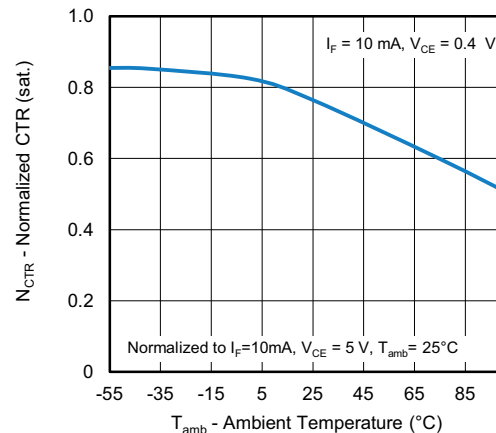


Fig. 10 - Normalized CTR vs. Ambient Temperature (saturated)

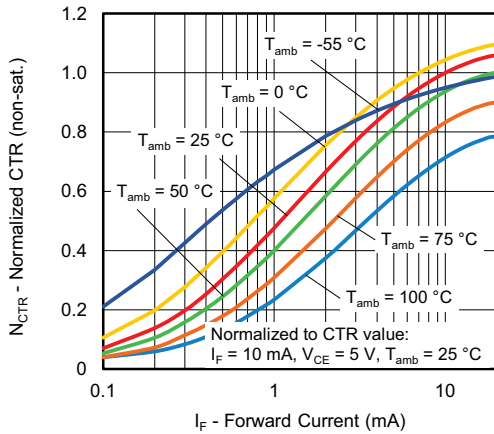


Fig. 11 - Normalized CTR (non-saturated) vs. Forward Current

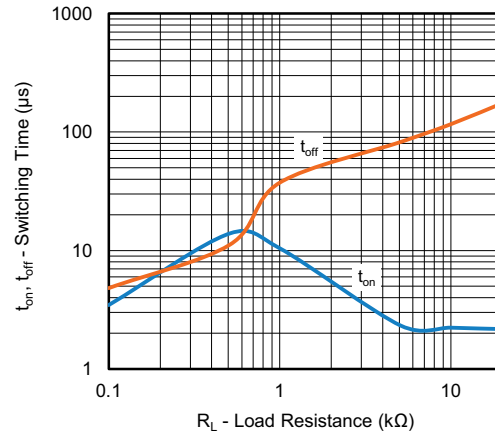


Fig. 13 - Switching Time vs. Load Resistance

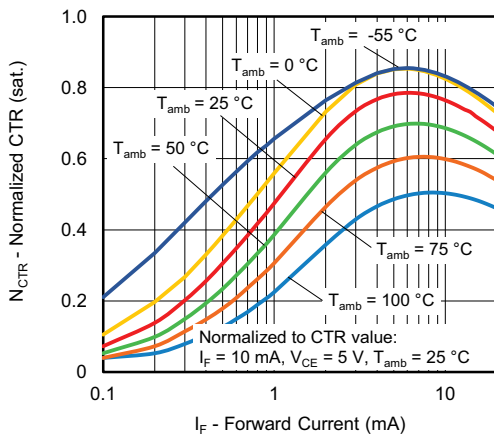


Fig. 12 - Normalized CTR (saturated) vs. Forward Current

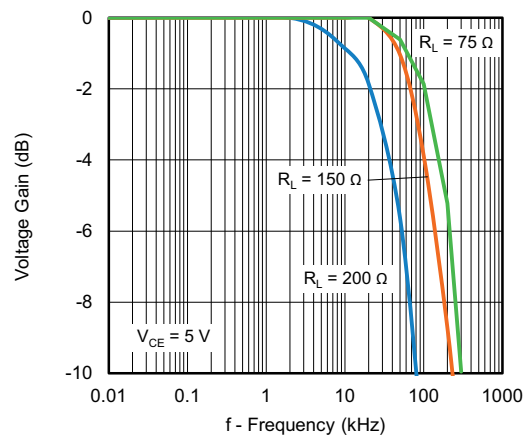
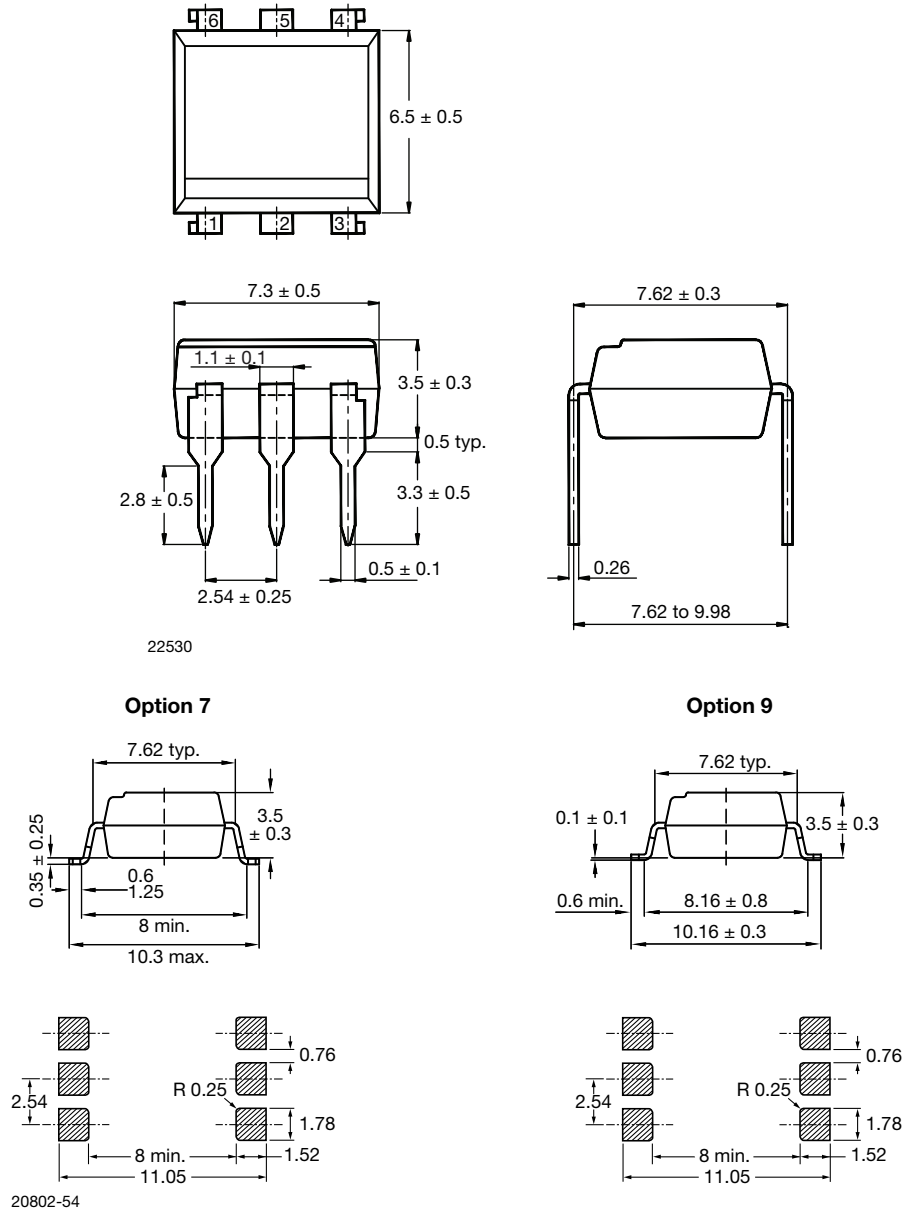


Fig. 14 - Voltage Gain vs. Frequency



PACKAGE DIMENSIONS in millimeters

6 Pin Package



PACKAGE MARKING



Fig. 15 - Example of H11D1

Notes

- “YWW” is the date code marking (Y = year code, WW = week code)
- VDE logo is only marked on VDE option parts
- Tape and reel suffix (T) is not part of the package marking



PACKAGING INFORMATION (in millimeters)

DEVICES PER TUBE			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
DIP-6	50	40	2000
SMD-6	50	40	2000

DIP-6

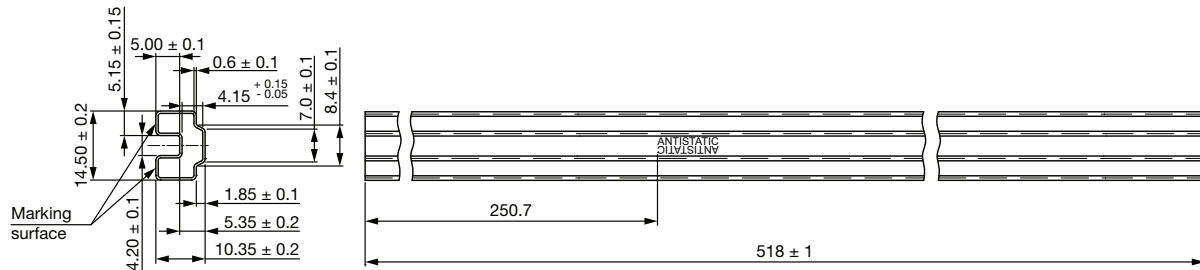


Fig. 16 - DIP-6

SMD-6

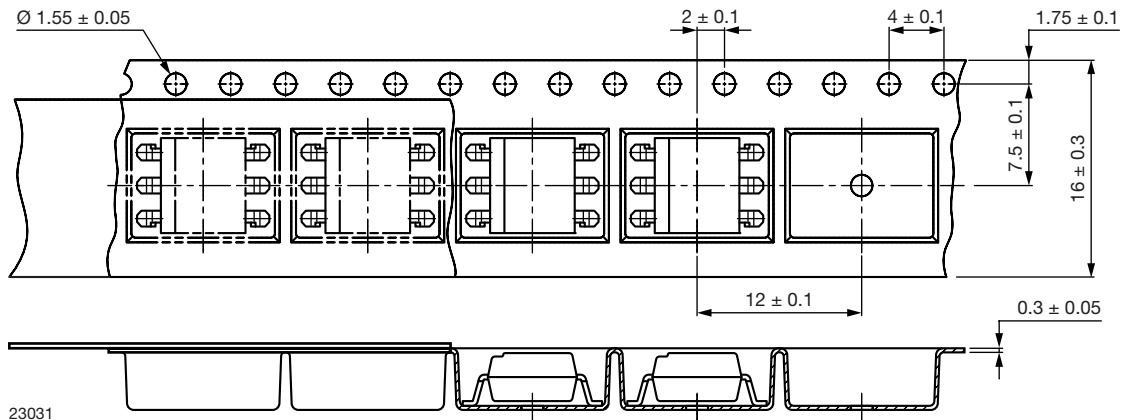


Fig. 17 - SMD-6

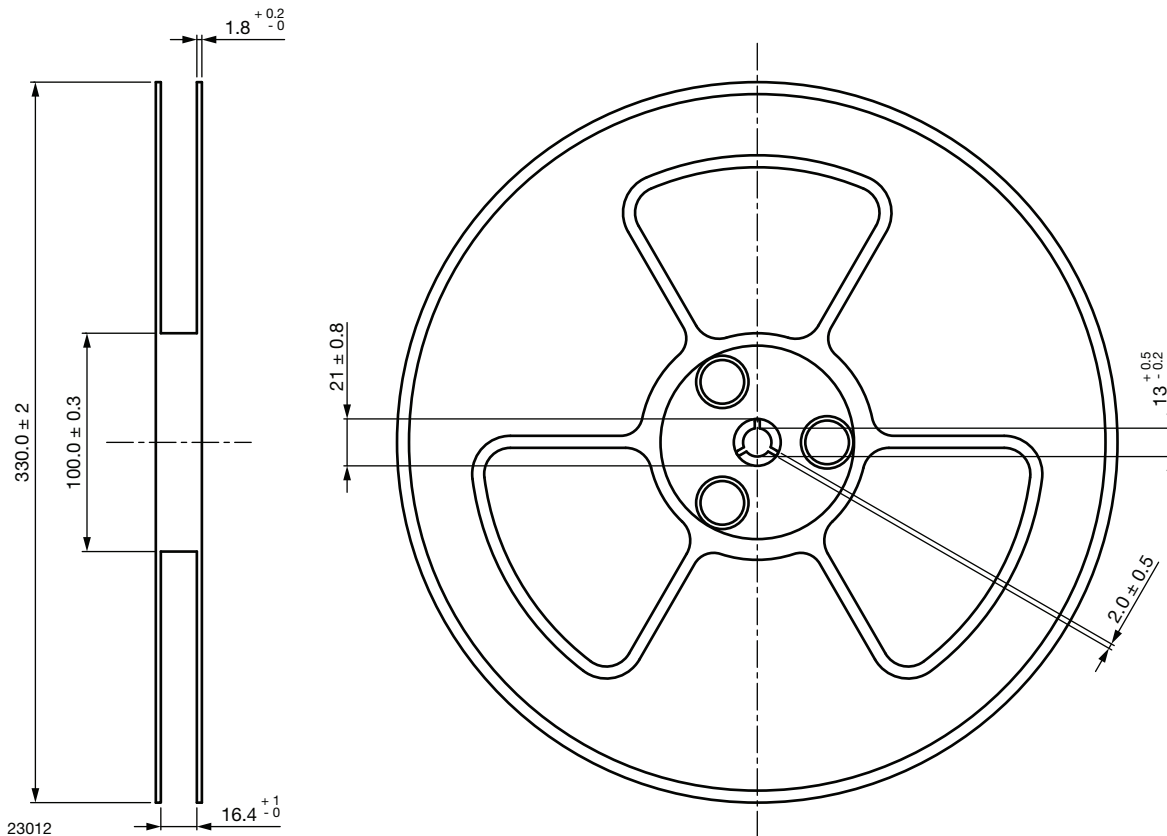
Reel


Fig. 18 - Tape and Reel Shipping Medium

SOLDER PROFILES
IR Reflow Soldering (JEDEC® J-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

PROFILE ITEM	CONDITIONS
Preheat	
- Temperature minimum ($T_{S \text{ min.}}$)	150 °C
- Temperature maximum ($T_{S \text{ max.}}$)	200 °C
- Time (min. to max.) (t_s)	90 s ± 30 s
Soldering zone	
- Temperature (T_L)	217 °C
- Time (t_L)	60 s
Peak temperature (T_p)	260 °C
Ramp-up rate	3 °C/s max.
Ramp-down rate	3 °C/s to 6 °C/s

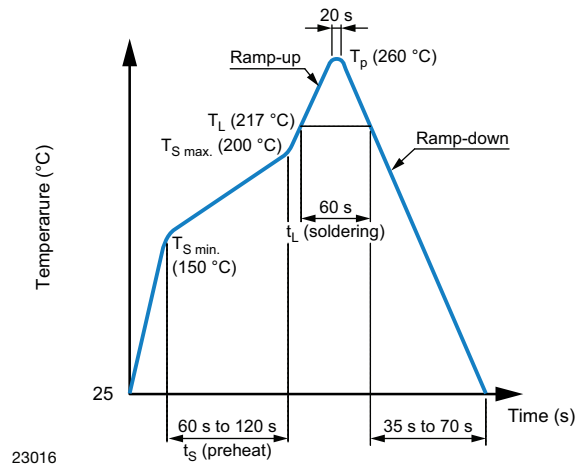


Fig. 19



Wave Soldering (JEDEC JESD22-A111 compliant)

One time soldering is recommended within the condition of temperature.

Temperature: 260 °C + 0 °C / - 5 °C

Time: 10 s

Preheat temperature: 25 °C to 140 °C

Preheat time: 30 s to 80 s

Hand Soldering by Soldering Iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380 °C + 0 °C / - 5 °C

Time: 3 s max.

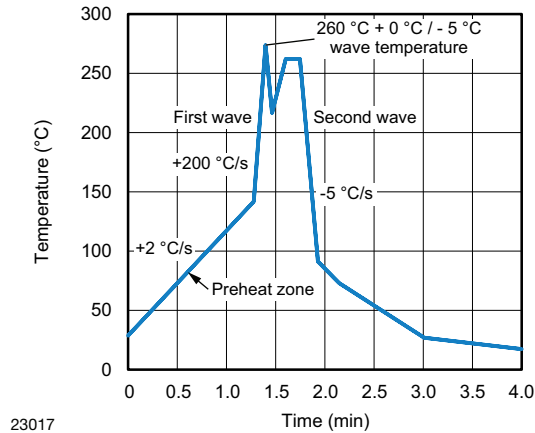


Fig. 20

23017



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